

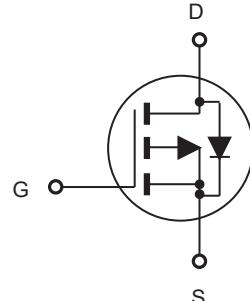


CEP14P20A/CEB14P20A CEF14P20A

P-Channel Enhancement Mode Field Effect Transistor

FEATURES

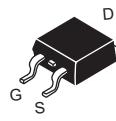
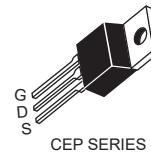
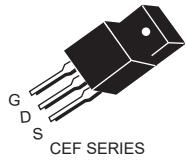
Type	V_{DSS}	$R_{DS(ON)}$	I_D	@ V_{GS}
CEP14P20A	-200V	275mΩ	-13.7A	-10V
CEB14P20A	-200V	275mΩ	-13.7A	-10V
CEF14P20A	-200V	275mΩ	-13.7A ^d	-10V



- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handing capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.

Applications

- Switched mode power supplies.
- Lighting.
- DC Motor control.
- Load switch.
- battery powered.

CEB SERIES
TO-263(DD-PAK)CEP SERIES
TO-220CEF SERIES
TO-220F

ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	V_{DS}	-200		V
Gate-Source Voltage	V_{GS}	± 30		V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	I_D	-13.7 -8.7	-13.7 ^d -8.7 ^d	A
Drain Current-Pulsed ^a	I_{DM} ^e	-54.8	-54.8 ^d	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25° C	P_D	104 0.83	34 0.27	W W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy ^g	E_{AS}	198		mJ
Single Pulsed Avalanche Current ^g	I_{AS}	11.5		A
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 150		°C

Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	R_{JC}	1.2	3.6	°C/W
Thermal Resistance, Junction-to-Ambient	R_{JA}	62.5	65	°C/W



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Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-200			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -200\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
On Characteristics^b						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = -250\mu\text{A}$	-2		-4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -6.8\text{A}$		220	275	$\text{m}\Omega$
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		3790		pF
Output Capacitance	C_{oss}			145		pF
Reverse Transfer Capacitance	C_{rss}			105		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}} = -100\text{V}, I_D = -13.5\text{A}, V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 25\Omega$		41		ns
Turn-On Rise Time	t_r			44		ns
Turn-Off Delay Time	$t_{\text{d(off)}}$			172		ns
Turn-Off Fall Time	t_f			73		ns
Total Gate Charge	Q_g	$V_{\text{DS}} = -160\text{V}, I_D = -13.5\text{A}, V_{\text{GS}} = -10\text{V}$		64		nC
Gate-Source Charge	Q_{gs}			11		nC
Gate-Drain Charge	Q_{gd}			22		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S^f				-13.7	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = -13.7\text{A}$			-1.5	V
Notes :						
a.Repetitive Rating : Pulse width limited by maximum junction temperature .						
b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.						
c.Guaranteed by design, not subject to production testing.						
d.Limited only by maximum temperature allowed .						
e.Pulse width limited by safe operating area .						
f.Full package $I_{S(\text{max})} = 8\text{A}$, g. $L = 3\text{mH}, I_{AS} = 11.5\text{A}, V_{DD} = 25\text{V}, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.						



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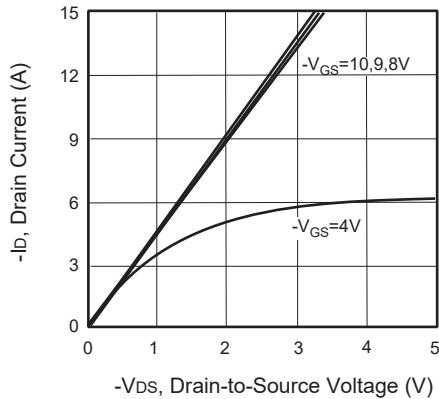


Figure 1. Output Characteristics

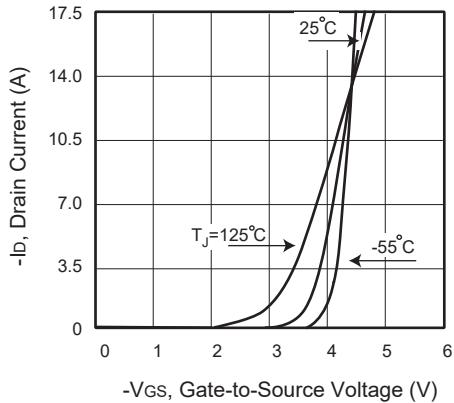


Figure 2. Transfer Characteristics

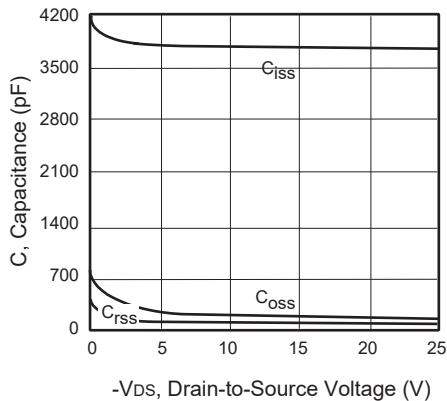


Figure 3. Capacitance

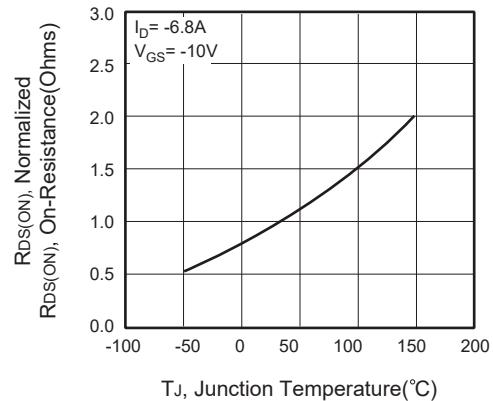


Figure 4. On-Resistance Variation with Temperature

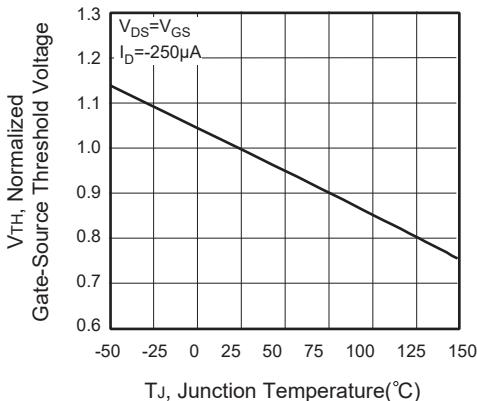


Figure 5. Gate Threshold Variation with Temperature

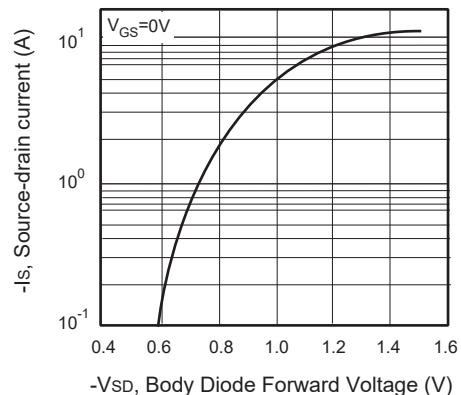


Figure 6. Body Diode Forward Voltage Variation with Source Current



CEP14P20A/CEB14P20A CEF14P20A

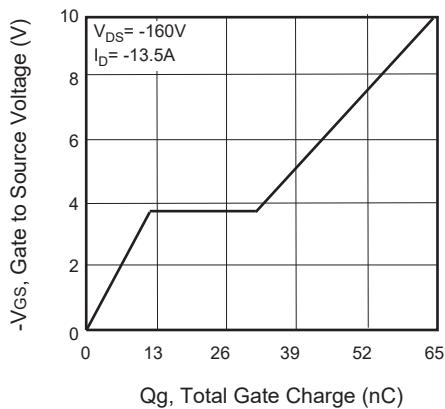


Figure 7. Gate Charge

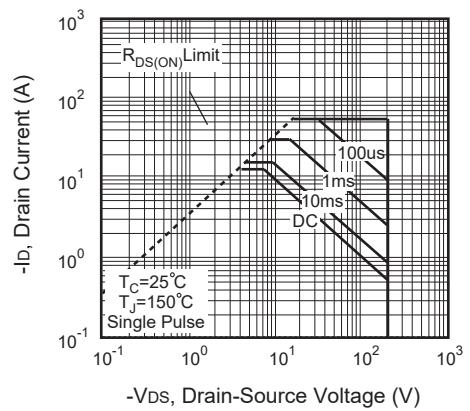


Figure 8. Maximum Safe
Operating Area

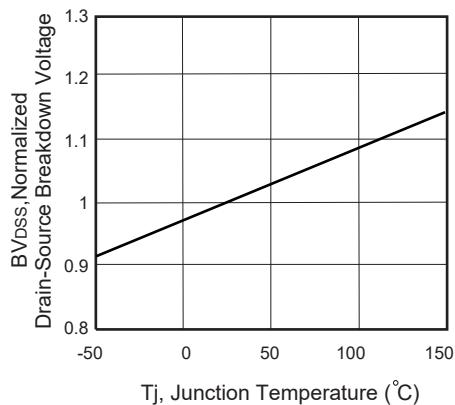


Figure 9. Breakdown Voltage Variation
VS Temperature

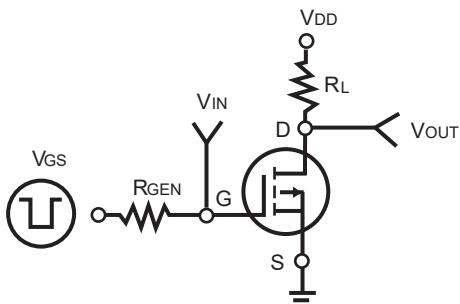


Figure 10. Switching Test Circuit

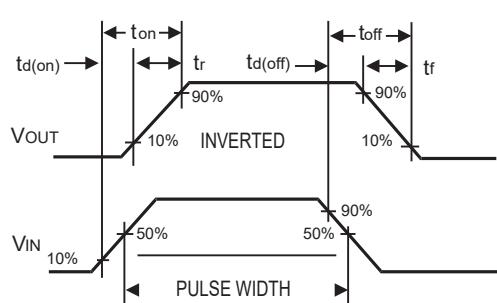


Figure 11. Switching Waveforms



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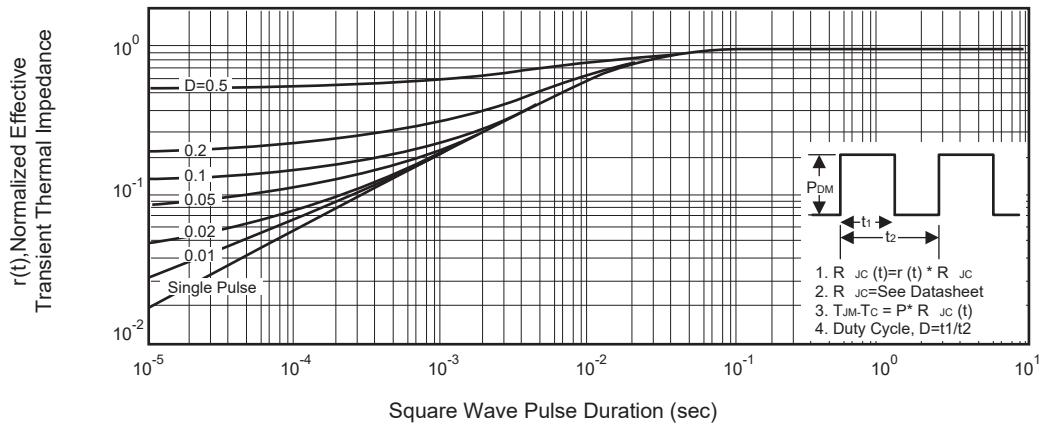


Figure 12. Normalized Thermal Transient Impedance Curve